# **OSRAM** KW H3L531.TE **Datasheet**



### OSLON® Black Flat

# **KW H3L531.TE**

Oslon Black Flat is able to meet a wide range of requirements in terms of output and adaptability to ambient conditions. It offers a uniform light pattern, thermal stability and great brightness.





### **Applications**

- Static Forward Lighting

#### **Features**

- Package: SMD epoxy package

- Chip technology: UX:3

- Typ. Radiation: 120° (Lambertian emitter)

- Color: Cx = 0.322, Cy = 0.334 acc. to CIE 1931 (• ultra white)

- Corrosion Robustness Class: 3B

- Qualifications: AEC-Q102 Qualified

- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



**Ordering Information** 

Type Luminous Flux 1) Ordering Code  $I_{\rm F}$  = 1000 mA

KW H3L531.TE-Z7Q6-ebvFfcbB46-DFYF 900 ... 1320 lm Q65112A4048



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min.	-40 °C
		max.	125 °C
Storage Temperature	T <sub>stg</sub>	min.	-40 °C
	9	max.	125 °C
Junction Temperature	$T_{j}$	max.	150 °C
Junction Temperature for short time applications*	T <sub>j</sub>	max.	175 °C
Forward current	I <sub>E</sub>	min.	50 mA
$T_S = 25  ^{\circ}C$		max.	1200 mA
Surge current	I <sub>FS</sub>	max.	2000 mA
$t \le 10 \ \mu s$ ; D = 0.005 ; $T_s = 25 \ ^{\circ}C$	10		
ESD withstand voltage	V <sub>ESD</sub>		8 kV
acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	200		
Reverse current 2)	I <sub>R</sub>	max.	200 mA

<sup>\*</sup> The median lifetime (L70/B50) for Tj =  $175^{\circ}$ C is 100h.



### **Characteristics**

 $I_F$  = 1000 mA;  $T_S$  = 25 °C

Parameter	Symbol	Values	
Chromaticity Coordinate 3)	Сх	typ.	0.322
	Су	typ.	0.334
Viewing angle at 50% I <sub>V</sub>	2φ	typ.	120 °
Radiating surface	A <sub>color</sub>	typ.	3.3 mm <sup>2</sup>
Forward Voltage 4)	$V_{F}$	min.	8.15 V
$I_{\rm F} = 1000  \text{mA}$	·	typ.	9.20 V
		max.	11.15 V
Reverse voltage (ESD device)	V <sub>R ESD</sub>	min.	45 V
Reverse voltage 2)	$V_R$	max.	1.2 V
$I_R = 20 \text{ mA}$			
Real thermal resistance junction/solderpoint <sup>5)</sup>	R <sub>thJS real</sub>	typ.	1.30 K / W
		max.	1.60 K / W
Electrical thermal resistance junction/solderpoint 5)	R <sub>thJS elec.</sub>	typ.	0.91 K / W
with efficiency $\eta_e$ = 30 %	the cice.	max.	1.12 K / W



### **Brightness Groups**

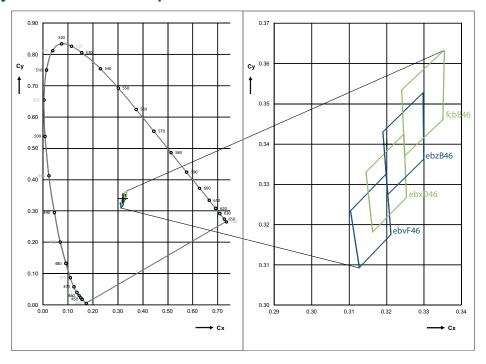
Group	Luminous Flux 1) I <sub>E</sub> = 1000 mA	Luminous Flux $^{1)}$ $I_{\rm F} = 1000 \text{ mA}$	Luminous Intensity <sup>6)</sup> I <sub>F</sub> = 1000 mA	
	min.	max.	typ.	
	$\Phi_{V}$	$\Phi_{V}$	$I_{\mathbf{v}}$	
7Q	900 lm	1000 lm	314 cd	_
7QF	949 lm	1060 lm	332 cd	
8Q	1000 lm	1120 lm	350 cd	
8QF	1060 lm	1180 lm	370 cd	
5R	1120 lm	1250 lm	391 cd	
5RF	1180 lm	1320 lm	413 cd	

# **Forward Voltage Groups**

Group Forward Voltage $^{4)}$ $I_{_{\rm F}}$ = 1000 mA min. $V_{_{\rm F}}$		Forward Voltage 4)  I <sub>F</sub> = 1000 mA  max.  V <sub>F</sub>	
DF	8.15 V	8.90 V	
UF	8.90 V	9.65 V	
GF	9.65 V	10.40 V	
YF	10.40 V	11.15 V	



# **Chromaticity Coordinate Groups** 3)



# Chromaticity Coordinate Groups 3)

Group	Сх	Су		Group	Сх	Су
ebvF46	0.3104	0.3234		ebzB46	0.3190	0.3430
	0.3199	0.3325			0.3298	0.3526
	0.3212	0.3175			0.3299	0.3361
	0.3127	0.3093			0.3203	0.3274
ebxD46	0.3145	0.3330		fcbB46	0.3241	0.3534
	0.3246	0.3424			0.3355	0.3633
	0.3253	0.3266			0.3350	0.3460
	0.3163	0.3181			0.3248	0.3370

KW H3L531.TE DATASHEET



### **Group Name on Label**

Example: 5R-ebvF46-DF

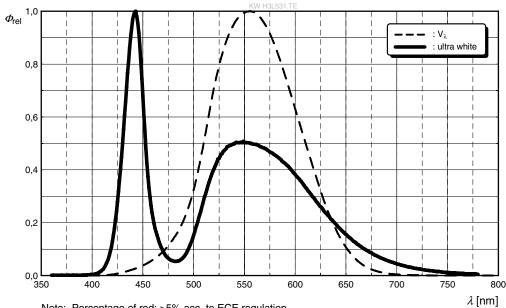
Brightness	Color Chromaticity	Forward Voltage
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5R DF ebvF46



### Relative Spectral Emission 6)

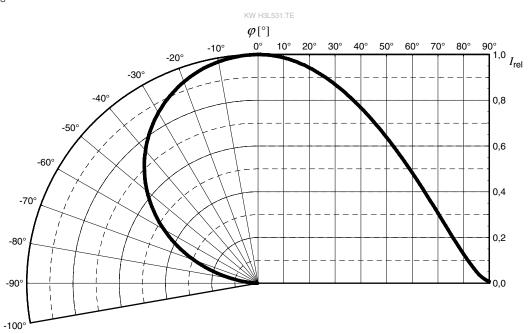
 $\Phi_{rel}$  = f ( $\lambda$ ); I $_{F}$  = 1000 mA;  $T_{S}$  = 25 °C



Note: Percentage of red: >5% acc. to ECE regulation Percentage of UV: <10-5 W/lm acc. to ECE regulation

### Radiation Characteristics 6)

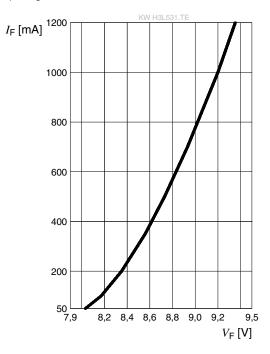
 $I_{rel} = f(\phi); T_{s} = 25 \, ^{\circ}C$ 





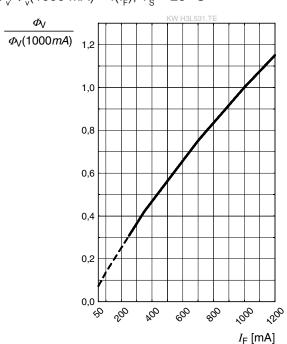
#### Forward current 6), 7)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



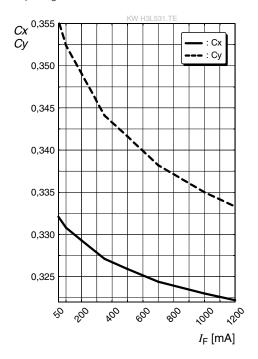
#### Relative Luminous Flux 6), 7)

$$\Phi_v \Phi_v (1000 \text{ mA}) = f(I_F); T_S = 25 \text{ }^{\circ}\text{C}$$



# Chromaticity Coordinate Shift 6)

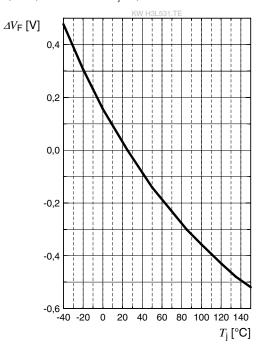
Cx, Cy = 
$$f(I_F)$$
;  $T_S = 25$  °C





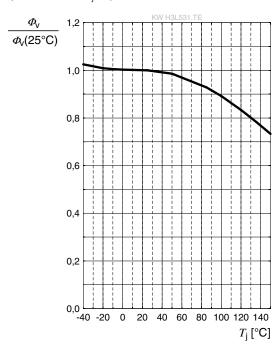
### Forward Voltage 6)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}C) = f(T_{_j}); I_{_F} = 1000~mA$$



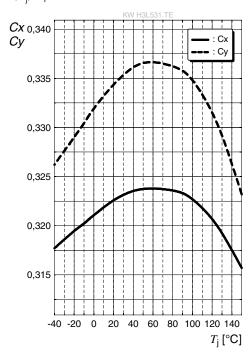
### Relative Luminous Flux 6)

$$\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 1000 \text{ mA}$$



## Chromaticity Coordinate Shift 6)

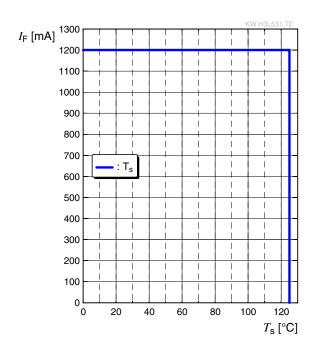
$$Cx, Cy = f(T_i); I_F = 1000 \text{ mA}$$





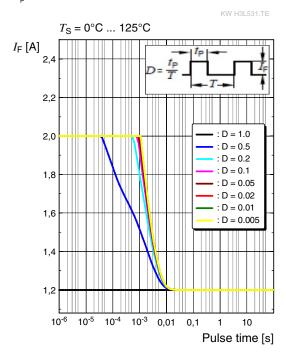
#### Max. Permissible Forward Current 5)

 $I_F = f(T); 0.7 * \Phi_{V min.}$  of bin 7Q;  $R_{th real max.}$ 



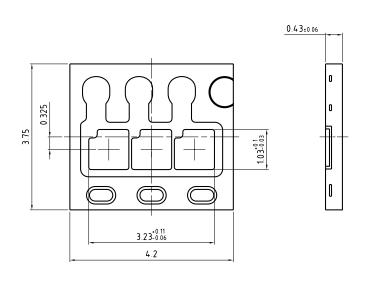
## Permissible Pulse Handling Capability

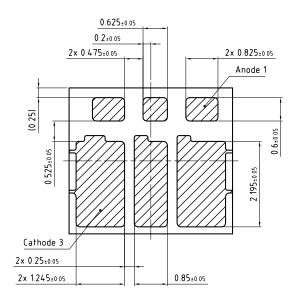
 $I_F = f(t_p)$ ; D: Duty cycle





### **Dimensional Drawing** 8)





Lead finish Au

genaral tolerance ±0.1

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#### **Further Information:**

**Approximate Weight:** 22.0 mg

**Corrosion test:** Class: 3B

Test condition: 40°C / 90 % RH / 15 ppm H<sub>2</sub>S / 14 days (stricter than IEC

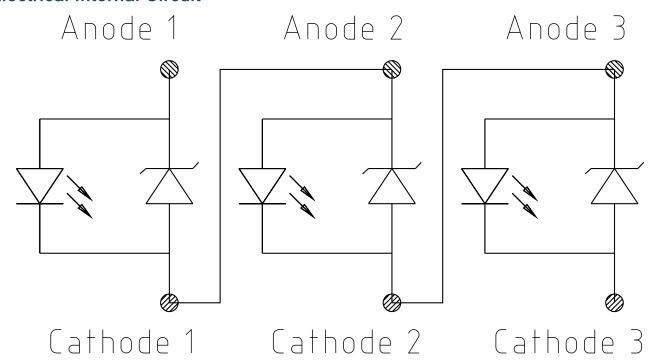
60068-2-43)

**ESD** advice: The device is protected by ESD device which is connected in parallel to the

Chip.

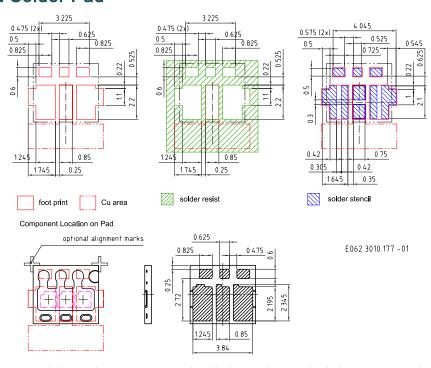


### **Electrical Internal Circuit**





#### Recommended Solder Pad 8)

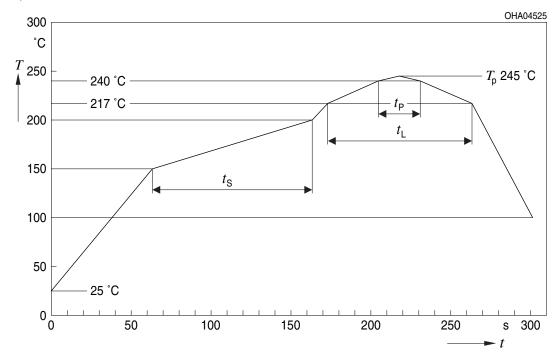


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.



### **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)	'		2	3	K/s
25 °C to 150 °C					
Time t <sub>s</sub>	t <sub>s</sub>	60	100	120	S
$T_{Smin}$ to $T_{Smax}$					
Ramp-up rate to peak*)			2	3	K/s
$T_{Smax}$ to $T_{P}$					
Liquidus temperature	$T_{L}$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle \perp}$		80	100	S
Peak temperature	T <sub>P</sub>		245	260	°C
Time within 5 °C of the specified peak	t <sub>P</sub>	10	20	30	S
temperature T <sub>P</sub> - 5 K					
Ramp-down rate* T <sub>P</sub> to 100 °C			3	6	K/s
Time 25 °C to T <sub>P</sub>				480	S
20 0 to 1 <sub>P</sub>					

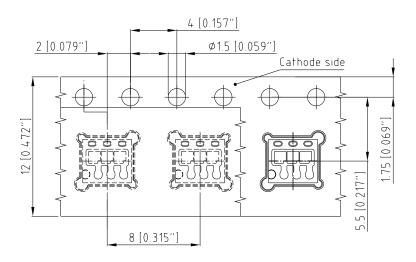
All temperatures refer to the center of the package, measured on the top of the component

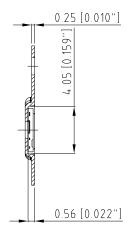
<sup>\*</sup> slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range



### Taping 8)



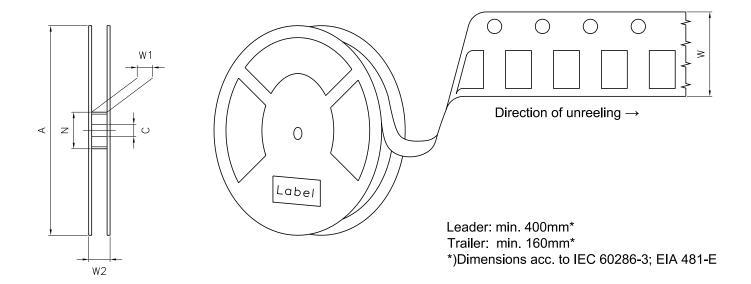




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### Tape and Reel 9)

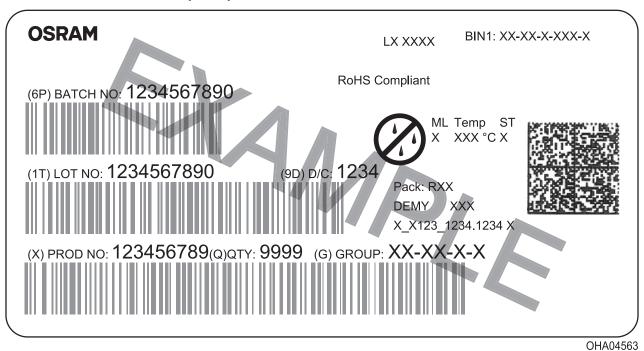


### **Reel Dimensions**

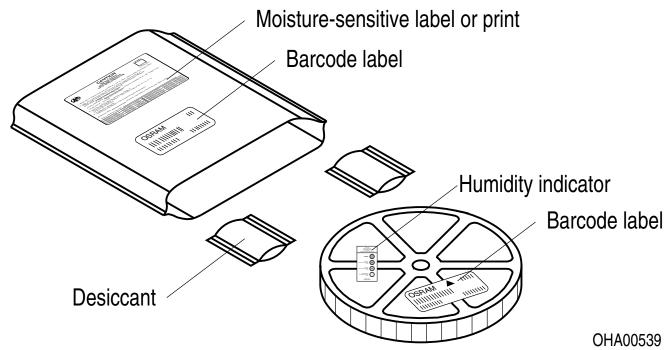
Α	W	$N_{\min}$	$W_1$	$W_{2  \text{max}}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000



### **Barcode-Product-Label (BPL)**



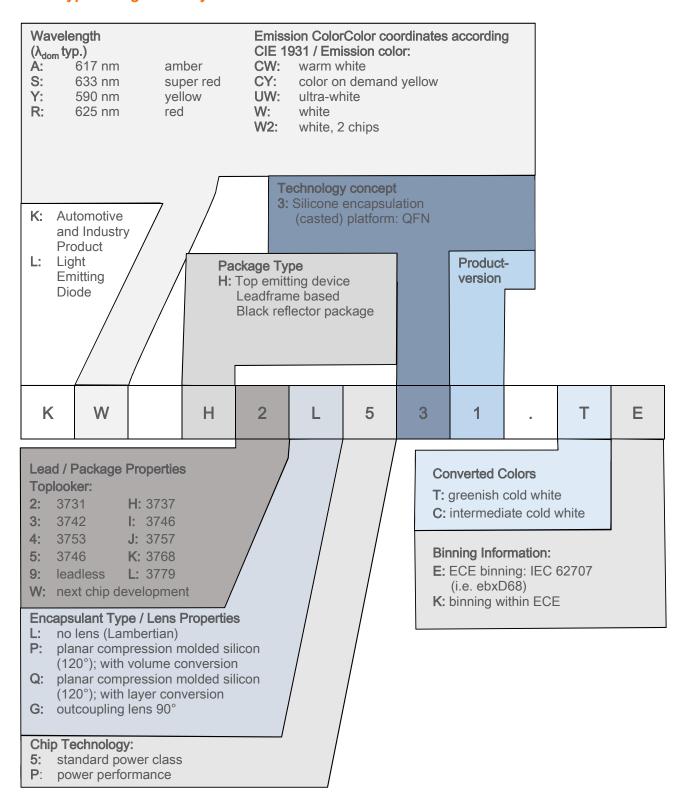
### Dry Packing Process and Materials 8)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



#### **Type Designation System**





#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class moderate risk (exposure time 0.25 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.



#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±0.005 and an expanded uncertainty of ±0.01 (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) Thermal Resistance: Rth max is based on statistic values (6 $\sigma$ ) used for Derating.
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- 9) Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision History					
Version	Date	Change			
1.6	2020-01-30	Features Further Information Recommended Solder Pad Reel Dimensions Schematic Transportation Box Dimensions of Transportation Box Type Designation System Notes Disclaimer			
1.7	2024-04-04	New Layout Applications			



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

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